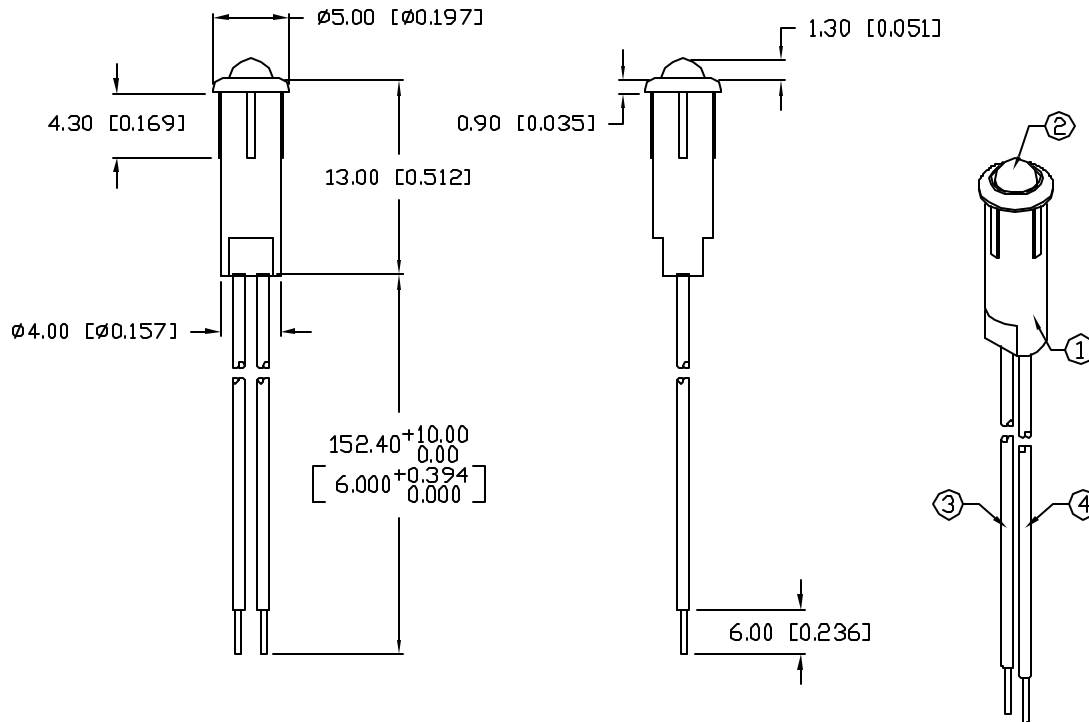


CAUTION: STATIC SENSITIVE DEVICE
FOLLOW PROPER E.S.D. HANDLING PROCEDURES
WHEN WORKING WITH THIS PART.



NOTES:

- SSH-LXH3121 HOLDER, BLACK NYLON 94-V.
- SSL-LX3044USBD LED, LEADS CUT TO 5mm.
- ANODE LEAD: LXP-WST26RDT0C, RED INSULATED LEAD, 26 AWG, CUT 158mm LONG, STRIP 3.0mm & 6.0mm.
- CATHODE LEAD: LXP-WST26BLT0C, BLACK INSULATED LEAD, 26 AWG, CUT 158mm LONG, STRIP 3.0mm & 6.0mm.
- MOUNTING HOLE: $\phi 0.170'' - \phi 0.174''$

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		470		nm	
FORWARD VOLTAGE		3.5	4.0	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		60		med	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	BLUE				
EPOXY LENS FINISH:	BLUE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	100	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	98	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= $\begin{matrix} +\text{DECIMAL PRECISION} \\ -0.00 \end{matrix}$ MAX= $\begin{matrix} +0.00 \\ -\text{DECIMAL PRECISION} \end{matrix}$

REV.

PART NUMBER

SSI-LXH312USBD-150

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T-3mm LED BLACK PANEL INDICATOR WITH 6" WIRE LEADS,
470nm ULTRA SUPER BLUE LED, BLUE DIFFUSED LENS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: GT	CHECKED BY:	APPROVED BY:	DATE: 7.5.01
			PAGE: 1 OF 1
			SCALE: N/A